



Ultra Low Power Sensor Controller TI BoosterPack™

plug-in module for the TI LaunchPad™ Development ecosystem

PART NO: BOOSTXL-ULPSENSE



BOOST
YOUR DESIGN

START @

dev.ti.com/BOOSTXL-ULPSENSE

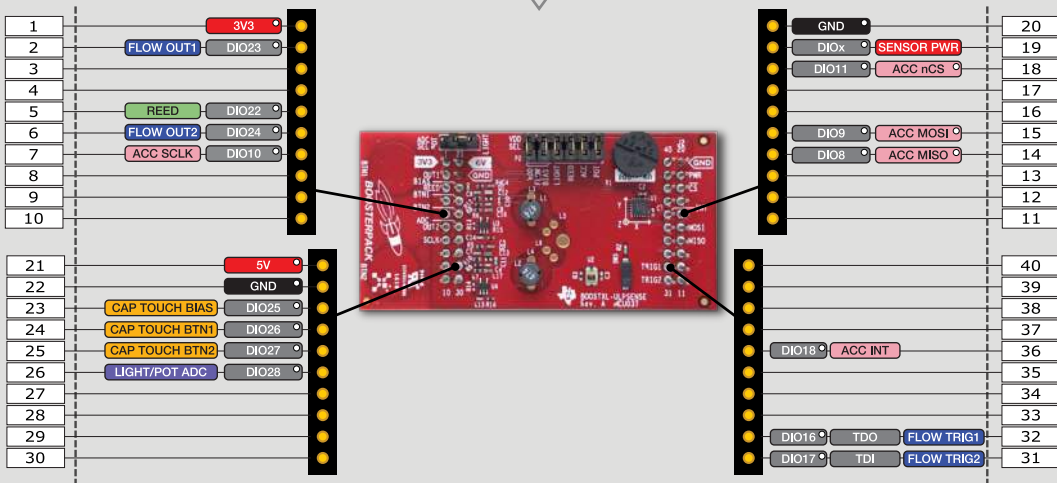


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Make your own boosterpack @ www.ti.com/byob
 ○ Pin aligns with BoosterPack pinout standard.



Explore all TI BoosterPack™ modules @ www.ti.com/boosterpacks

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